

Automotive-grade N-channel 40 V, 0.9 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

 PowerFLAT™ 5x6

 Figure 1: Internal schematic diagram



Datasheet - production data

Features

| Order code | VDS | R _{DS(on)} max | ID |
|--------------|------|-------------------------|-------|
| STL285N4F7AG | 40 V | 1.1 mΩ | 120 A |

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

Switching applications

Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

| Order code | Marking | Package | Packaging |
|--------------|---------|----------------|---------------|
| STL285N4F7AG | 285N4F7 | PowerFLAT™ 5x6 | Tape and reel |

DocID028752 Rev 2

This is information on a product in full production.

Contents

Contents

| 1 | Electric | al ratings | 3 |
|---|----------|--|----|
| 2 | Electric | al characteristics | 4 |
| | 2.1 | Electrical characteristics (curves) | 6 |
| 3 | Test cir | cuits | 8 |
| 4 | Packag | e mechanical data | 9 |
| | 4.1 | PowerFLAT™ 5x6 WF type C package information | 9 |
| | 4.2 | PowerFLAT™ 5x6 packing information | 12 |
| 5 | Revisio | n history | 14 |



1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-------------------------------|---|--------|------|
| V _{DS} | Drain-source voltage | 40 | V |
| V _{GS} | Gate-source voltage | ± 20 | V |
| I _D ⁽¹⁾ | Drain current (continuous) at T _C = 25 °C | 120 | А |
| اD ⁽¹⁾ | Drain current (continuous) at T _C = 100 °C | | А |
| IDM ⁽¹⁾⁽²⁾ | Drain current (pulsed) | 480 | А |
| Ртот | Total dissipation at $T_c = 25 \text{ °C}$ | 188 | W |
| IAV | Avalanche current, repetitive or not repetitive (pulse width limited by maximum junction temperature) | | А |
| Eas | Single pulse avalanche energy (T _j = 25 °C, I_D = 24 A, V_{DD} = 25 V) | 280 | mJ |
| Tj | Operating junction temperature range | -55 to | ℃ |
| T _{stg} | Storage temperature range | 175 | |

Notes:

 $^{(1)}\mbox{Drain current}$ is limited by package, the current capability of the silicon is 310 A at 25 °C.

⁽²⁾Pulse width limited by safe operating area

Table 3: Thermal data

| Symbol | Parameter | Value | Unit |
|-------------------------|---------------------------------------|-------|------|
| Rthj-pcb ⁽¹⁾ | Thermal resistance junction-pcb max. | 31.3 | °C/W |
| Rthj-case | Thermal resistance junction-case max. | 0.8 | °C/W |

Notes:

 $^{(1)}\!When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.



2 Electrical characteristics

(Tc = 25 °C unless otherwise specified)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|--------------------------------------|---|------|------|------|------|
| V(BR)DSS | Drain-source breakdown voltage | V_{GS} = 0 V, I_D = 250 μ A | 40 | | | V |
| I _{DSS} | Zero gate voltage drain current | V _{GS} = 0 V V _{DS} = 40 V | | | 1 | μA |
| I _{GSS} | Gate-body leakage current | $V_{GS}=20~V,~V_{DS}=0~V$ | | | 100 | nA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 2 | | 4 | V |
| R _{DS(on)} | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 24 \text{ A}$ | | 0.9 | 1.1 | mΩ |

Table 4: On /off states

Table 5: Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-----------------|------------------------------|--|------|------|------|------|
| Ciss | Input capacitance | | - | 5600 | - | pF |
| Coss | Output capacitance | V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0 V | - | 2400 | - | pF |
| Crss | Reverse transfer capacitance | | | 35 | - | pF |
| Qg | Total gate charge | $V_{DD} = 20 V, I_D = 48 A,$ | - | 67 | - | nC |
| Qgs | Gate-source charge | $V_{GS} = 10 V$ | - | 31 | - | nC |
| Q _{gd} | Gate-drain charge | (see Figure 14: "Test circuit for gate charge behavior") | - | 9 | - | nC |

Table 6: Switching times

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| t _{d(on)} | Turn-on delay time | $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 48 \text{ A},$ | - | 30 | - | ns |
| tr | Rise time | R_G = 4.7 Ω , V_{GS} = 10 V | - | 21 | - | ns |
| t _{d(off)} | Turn-off delay time | (see Figure 13: "Test circuit for resistive load | - | 42 | - | ns |
| t _f | Fall time | switching times" and Figure 18: "Switching time waveform") | - | 13 | - | ns |

Electrical characteristics

| | Table 7: Source-drain diode | | | | | |
|--------------------------------|-----------------------------|---|------|------|------|------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| V _{SD} ⁽¹⁾ | Forward on voltage | $I_{SD} = 48 \text{ A}, V_{GS} = 0 \text{ V}$ | - | | 1.2 | V |
| trr | Reverse recovery time | I _D = 48 A, di/dt = 100 A/µs | - | 68 | | ns |
| Qrr | Reverse recovery charge | V _{DD} = 32 V | - | 98 | | nC |
| Irrm | Reverse recovery current | (see Figure 15: "Test circuit for inductive load switching and diode recovery times") | - | 2.9 | | A |

Notes:

 $^{(1)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%













Electrical characteristics







57

3 Test circuits









4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 PowerFLAT[™] 5x6 WF type C package information



Figure 19: PowerFLAT™ 5x6 WF type C package outline



Package mechanical data

STL285N4F7AG

| nechanical data | hanical data STL285N4F7AG | | | | |
|-----------------|---------------------------|-------------------------------|-------|--|--|
| Та | able 8: PowerFLAT™ 5x6 | 3 WF type C mechanical | data | | |
| Dim | | mm | | | |
| Dim. | Min. | Тур. | Max. | | |
| A | 0.80 | | 1.00 | | |
| A1 | 0.02 | | 0.05 | | |
| A2 | | 0.25 | | | |
| b | 0.30 | | 0.50 | | |
| С | 5.80 | 6.00 | 6.10 | | |
| D | 5.00 | 5.20 | 5.40 | | |
| D2 | 4.15 | | 4.45 | | |
| D3 | 4.05 | 4.20 | 4.35 | | |
| D4 | 4.80 | 5.00 | 5.10 | | |
| D5 | 0.25 | 0.40 | 0.55 | | |
| D6 | 0.15 | 0.30 | 0.45 | | |
| е | | 1.27 | | | |
| E | 6.20 | 6.40 | 6.60 | | |
| E2 | 3.50 | | 3.70 | | |
| E3 | 2.35 | | 2.55 | | |
| E4 | 0.40 | | 0.60 | | |
| E5 | 0.08 | | 0.28 | | |
| E6 | 0.20 | 0.325 | 0.45 | | |
| E7 | 0.85 | 1.00 | 1.15 | | |
| E9 | 4.00 | 4.20 | 4.40 | | |
| E10 | 3.55 | 3.70 | 3.85 | | |
| К | 1.05 | | 1.35 | | |
| L | 0.90 | 1.00 | 1.10 | | |
| L1 | 0.175 | 0.275 | 0.375 | | |
| θ | 0° | | 12° | | |

57

Package mechanical data



57

DocID028752 Rev 2

11/15

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm) P2 2.0±0.05(l) Po 4.0±0.1(**II**) Do E1 1.75±0.1 Т Ø1.50 0.0 0.30±0.05 Y_ \oslash \oplus \bigcirc \bigcirc \oplus \oplus \bigcirc \bigcirc F(5.50±0.0.05)(III) D1 Ø1.50MIN W(12.00±0.1) Bo (5.35±0.05) R0.30 MAX Ao(6.70±0.1) Ko (1.20±0.1) P1(8.00±0.1) SECTION Y-Y (I) Measured from centreline of sprocket hole to centreline of pocket. (II) Cumulative tolerance of 10 sprocket Base and bulk quatity 3000 pcs holes is ± 0.20. (III) Measured from centreline of sprocket hole to centreline of pocket. 8234350<u>T</u>apeWF<u>r</u>ev_C

4.2 PowerFLAT[™] 5x6 packing information

Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape









5 Revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 10-Dec-2015 | 1 | First release. |
| 09-Jun-2016 | 2 | Modified: title Modified: <i>Table 4: "On /off states"</i> Updated: <i>Figure 7: "Static drain-source on-resistance"</i> Minor text changes |

Table 9: Document revision history



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